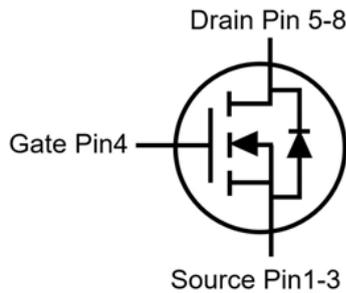
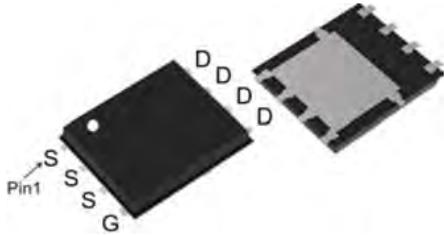


## SGT N-channel Power MOSFET

### MTR9R5N10SD PDFN5x6



$V_{DS}$	100	V
$R_{DS(on),TYP}@ V_{GS}=10V$	7.8	m $\Omega$
$I_D$	62	A

### Features

- 1、 Low on – resistance
- 2、 High power package (PDFN5X6)
- 3、 SGT N-channel Power MOSFET
- 4、 Halogen free

### Applications

- 1、 Load Switch for Portable Devices
- 2、 DC/DC Converter

### Maximum ratings, at $T_A = 25^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	100	V
$V_{GS}$	Gate-Source voltage	$\pm 20$	V
$I_S$	Diode continuous forward current	$T_C = 25^\circ\text{C}$ 62	A
$I_D$	Continuous drain current @ $V_{GS}=10V$	$T_C = 25^\circ\text{C}$ 62	A
		$T_C = 100^\circ\text{C}$ 50	A
$I_{DM}$	Pulse drain current tested ①	$T_C = 25^\circ\text{C}$ 200	A
$E_{AS}$	Avalanche energy, single pulsed ②	162	mJ
$P_D$	Maximum power dissipation	$T_C = 25^\circ\text{C}$ 62.5	W
$T_{STG}, T_J$	Storage and Junction Temperature Range	-55 to 150	$^\circ\text{C}$

## Thermal Characteristics

Symbol	Parameter	Rating	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	2.0	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	62	°C/W

## Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
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Static Electrical Characteristics @T<sub>j</sub>=25°C (unless otherwise stated)

V(BR)DSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	100	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	--	--	1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	2.0	3.0	V
R <sub>DS(on)</sub>	Drain-Source On-State Resistance ④	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	--	7.8	9.5	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	--	11.2	15	mΩ

Dynamic Electrical Characteristics @T<sub>j</sub> = 25°C (unless otherwise stated)

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V , f=1MHz	--	1662	--	pF
C <sub>oss</sub>	Output Capacitance		--	298	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	7.5	--	pF
R <sub>g</sub>	Gate Resistance	f=1MHz	--	1.5	--	Ω
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>DS</sub> =50V, I <sub>D</sub> =20A, V <sub>GS</sub> =10V	--	27.6	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	4.8	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	6.4	--	nC

## Switching Characteristics

Td(on)	Turn-on Delay Time	V <sub>DD</sub> =50V, V <sub>GS</sub> =10V I <sub>D</sub> =5A, R <sub>G</sub> =3Ω,	--	9.5	--	ns
Tr	Turn-on Rise Time		--	6	--	ns
Td(off)	Turn-Off Delay Time		--	2.8	--	ns
Tf	Turn-Off Fall Time		--	6.2	--	ns

## Source- Drain Diode Characteristics@ T<sub>j</sub> = 25°C (unless otherwise stated)

VSD	Forward on voltage	I <sub>SD</sub> =20A, V <sub>GS</sub> =0V	--	0.85	1.2	V
Trr	Reverse Recovery Time	I <sub>F</sub> =20A, V <sub>GS</sub> =0V	--	35	--	ns
Qrr	Reverse Recovery Charge	di/dt=500A/μs	--	175	--	nC

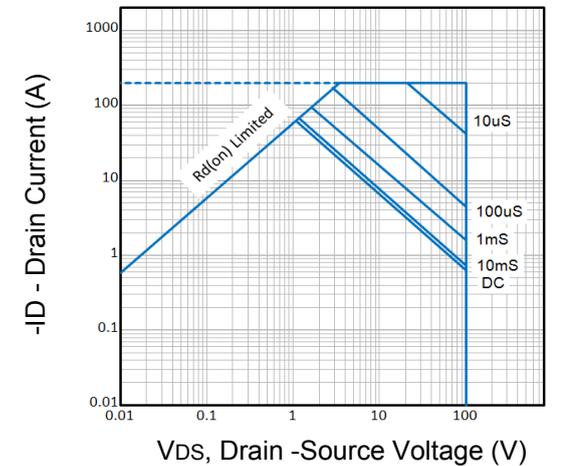
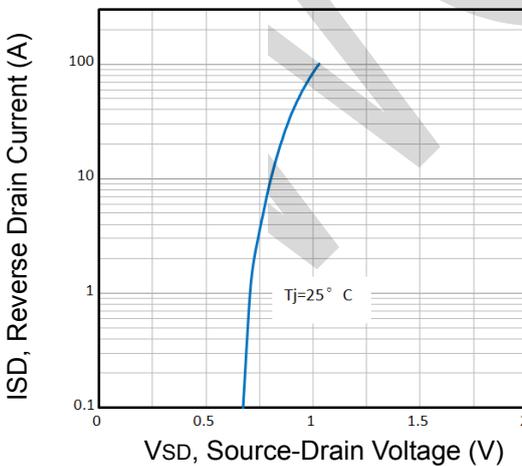
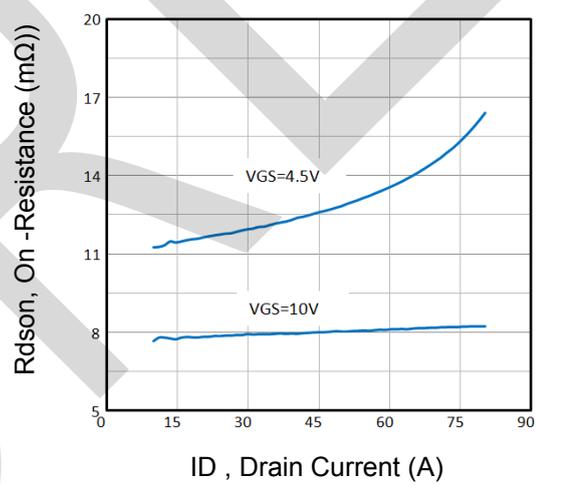
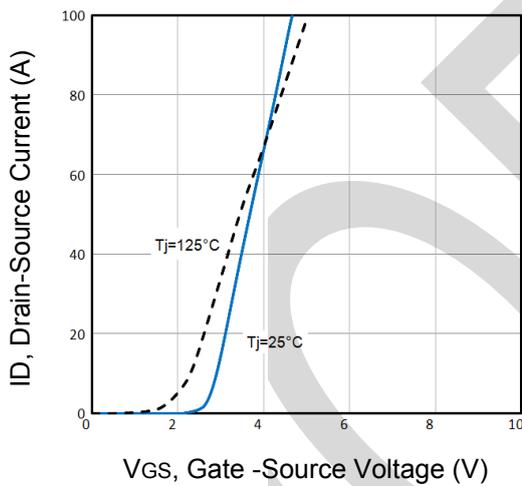
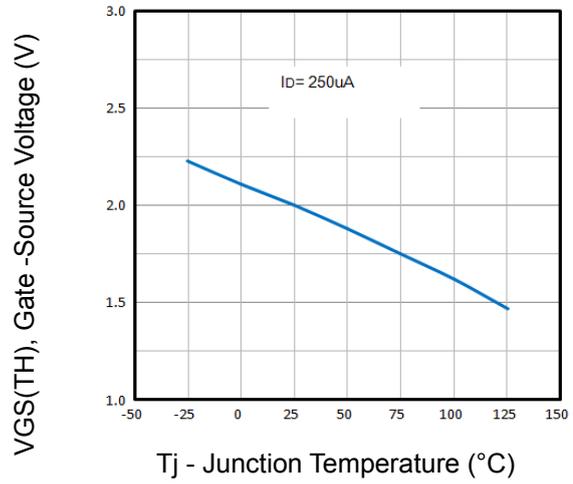
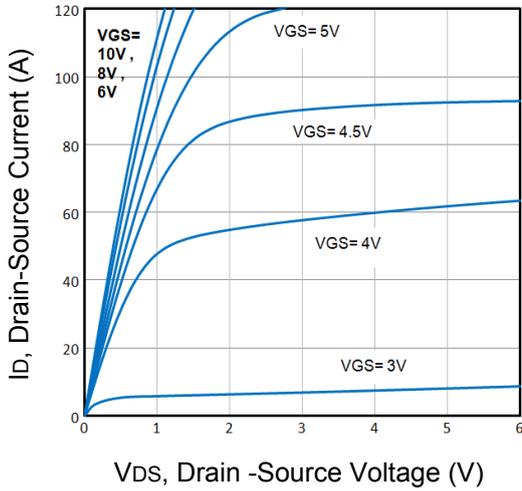
NOTE: ① Repetitive rating; pulse width limited by max junction temperature.

② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.1mH, R<sub>G</sub> = 25Ω, I<sub>AS</sub> = 57A, V<sub>GS</sub> = 10V. Part not recommended for use above this value

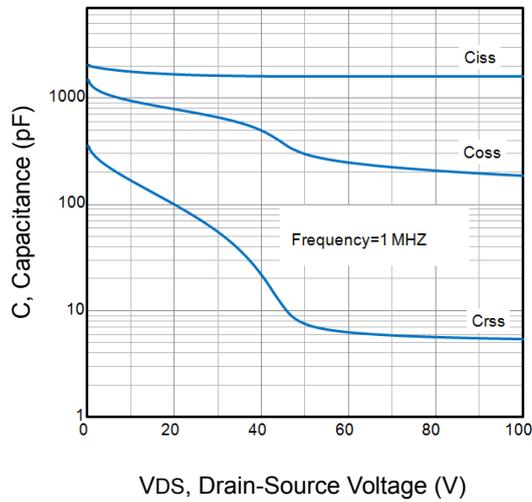
③ The power dissipation P<sub>DSM</sub> is based on R<sub>θJA</sub> and the maximum allowed junction temperature of 150°C.

④ Pulse width ≤ 380μs; duty cycle ≤ 2%.

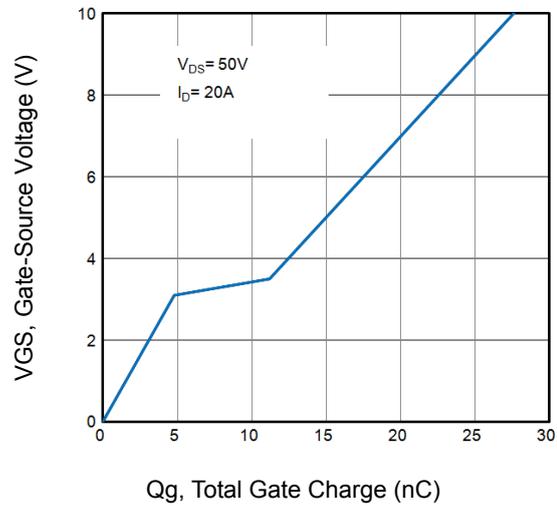
## Typical Characteristics



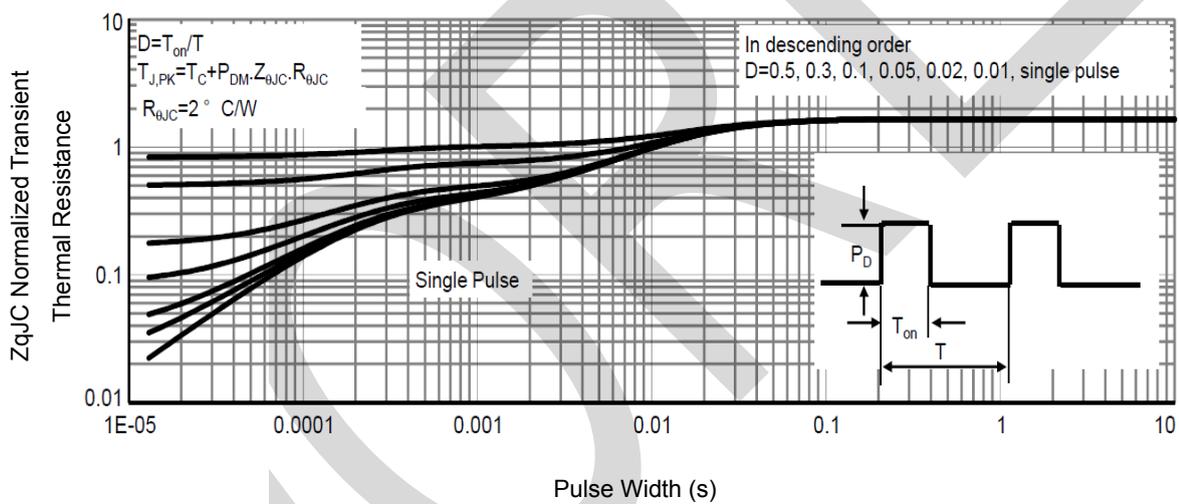
## Typical Characteristics



**Fig7.** Typical Capacitance Vs. Drain-Source Voltage

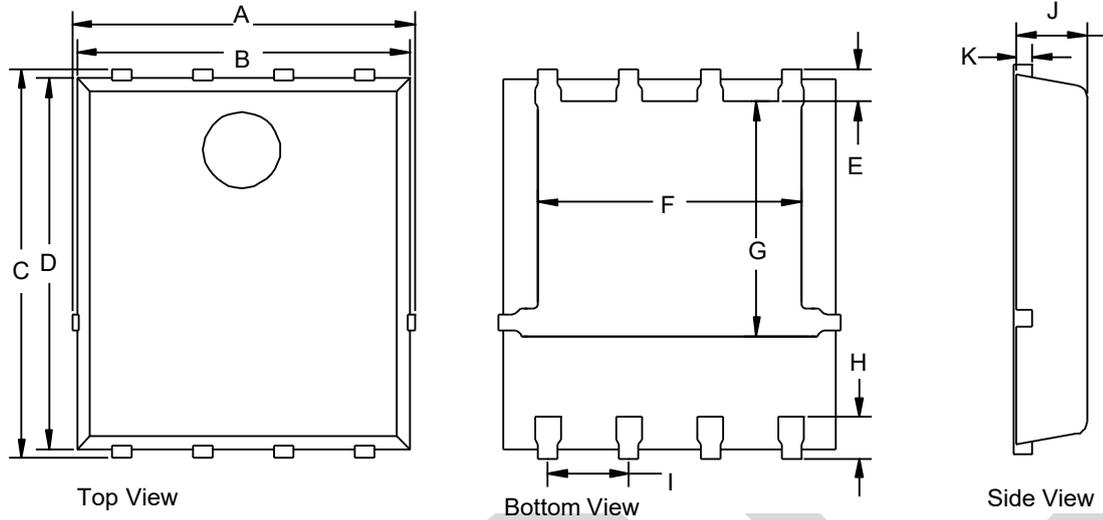


**Fig8.** Typical Gate Charge Vs. Gate-Source Voltage



**Fig9.** Normalized Maximum Transient Thermal Impedance

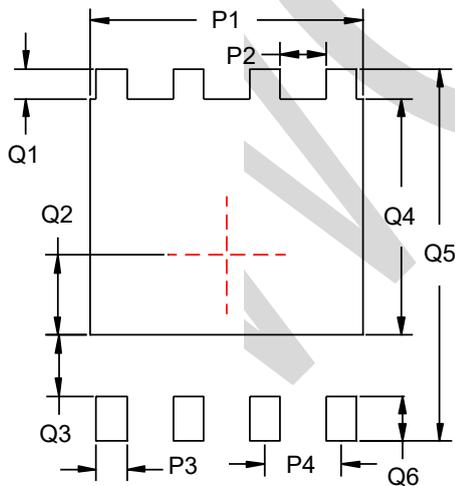
## PACKAGE OUTLINE DIMENSIONS



## PDFN5x6 mechanical data

UNIT		A	B	C	D	E	F	G	H	I	J	K
mm	min	4.90	4.8	5.90	5.66	0.60	3.90	3.30	0.53	1.27	0.9	0.254
	max	5.55	5.4	6.35	6.06		4.32	3.92	0.76		1.2	
mil	min	192.9	188.9	232.3	222.8	23.6	153.5	129.9	20.8	50.0	35.4	10.0
	max	218.5	212.6	250.0	238.6		170.1	154.3	29.9		47.2	

## PDFN5x6 Suggested Pad Layout



UNIT		P1	P2	P3	P4	Q1
mm	min	4.52	0.76	0.51	1.27	0.50
mil	min	177.9	29.9	20.07	50.0	20.0

UNIT		Q2	Q3	Q4	Q5	Q6
mm	min	1.34	1.02	3.97	6.25	0.76
mil	min	52.75	40.15	156.30	246.06	29.92